

「以爲、中囑、其、勿、至、此、也、」 各、明、者、皆、有、之、以、其、所、爲、也、
故、曰、不、可、也、

以上各埠、郵便、均先於本國籍法、三欄、民名、內、訂定最
後者於本國籍法、

「名称」発明に關し、請求書「範圍」に記載の特許請求事項の主題が本来の、最初にして唯一の発明者である一人の氏名が明記・主欄に記載されている場合、その氏名は本来の、最初にして其唯一の発明者である一発明の氏名が主欄に記載され、同一場合、主欄に

上記発明の明細書（下記が欄で示す限り）においていない場合は、本書に添付する。

□ 年 月 日に提出され、文庫出願番号
 _____ 上七、（該当する場合）
 年 月 日に評定されました。又は、

特許協定条約国際出願番号 _____ とし、
(該当する場合) _____ 年 _____ 月 _____ 日に公開されました。

以後、前記のとおり補正した請求の範囲を含む前記明細書の内容を検討し、理解したことを陳述する。

私は、連邦規則法典第一編第一章に「地に定義されていると」
り、特許資格の有無について重要な情報を開示すべき義務がある
ことを認めます。

[illegible]

Prior foreign applications

2001-000354
(Number)

Japan
Country

05/Jan/01
Day Month Year Filed

My residence, post office address and citizenship are as stated below next to my name:

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

Assembly For Shielded Terminal And Method For

Assembling Shielded Terminal

the specification of which is attached hereto unless the following box is checked:

☐ was filed on _____ as United States
Application Number _____ and was amended
on _____ (if applicable) or,

PCT International Application Number _____
and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority under Title 35, United States Code §119(a-d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT international application which designated at least one country other than the United States, listed below. I have also identified below, by checking the "No" box, any foreign application for patent or inventor's certificate, or of any PCT international application having a filing date before that of the application on which priority is claimed:

Priority claimed from

☒ Yes ☐ No

Additional foreign application numbers are listed on a supplemental priority sheet attached hereto.

I hereby claim the benefit under Title 35, United States Code §119 (e) of any United States provisional application(s) listed below.

(Day/Month/Year Filed)

[illegible]

(Day/Month/Year Filed)

1. $\frac{1}{2} \log \frac{1}{2}$, $\frac{1}{2} \log \frac{1}{2}$, $\frac{1}{2} \log \frac{1}{2}$, $\frac{1}{2} \log \frac{1}{2}$

(Day/Month/Year Filed)

COPIES OF THE REPORT

☐ Additional provisional application numbers are listed on a supplemental priority sheet attached hereto.

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s), or §365(c) of any PCT international application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Day/Month/Year Filed)

Cheng, J., & Wu, J. (2005).

(Day/Month/Year Filed)

0 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 21 22 23 24 25 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 44 45 46 47 48 49 50 51 52 53 54 55 56 57 58 59 60 61 62 63 64 65 66 67 68 69 70 71 72 73 74 75 76 77 78 79 80 81 82 83 84 85 86 87 88 89 90 91 92 93 94 95 96 97 98 99

☐ Additional U.S. or international application numbers are listed on a supplemental priority sheet attached hereto.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

The undersigned hereby authorizes the U.S. attorney or agent

and the undersigned, at the event of a change in the persons from whom instructions may be taken, the U.S. attorney or agent named herein will be so notified by the undersigned.

Japanese Language Utility or Design Patent Application Declaration

委任状：私は、下記発明者または、下記明記された顧客番号を有する特許を擁する、代理人をここに委任し、本願の手続きを遂行するにあたり、私は、発明者、一切の行為を特許審議院に対して行うべきを委任する。そして全ての通信は、この顧客番号宛に送られる。

顧客番号

POWER OF ATTORNEY: As a named inventor, I hereby appoint the attorney(s) and/or agent(s) associated with the Customer Number provided below to prosecute this application and transact all business in the Patent and Trademark Office connected therewith, and direct that all correspondence be addressed to that Customer Number:

CUSTOMER NUMBER 7055

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